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To: Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA. 22313-14509

Fr: Stephen B. Ackerman, Reg. No. 37,761  
28 Davis Ave.  
Poughkeepsie, N.Y. 12603

May 6, 2003  
RECEIVED  
MAY 23 2003  
TECHNOLOGY CENTER 2800  
05/02/01

Subject: Serial No. 09/846,536

W. T. Chu et al

"SELF ALIGNED, LOW CONTACT RESISTANCE,  
VIA FABRICATION PROCESS"

GRP. Art. Unit 2811

O. Nadav

RESPONSE PATENT OFFICE ACTION

Dear Sir;

In response to the FINAL Office Action dated March 20, 2003, please amend the identified application for patent as follows:

The commissioner is hereby authorized to charge payment of any additional fees involved with added Claims and the like to Deposit Account No. 19-0033

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA. 22313-1450, on May 20, 2003.

Stephen B. Ackerman, Reg. No. 37,761

Signature [Signature]

Date 5/20/03

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